# Quad MECL-to-TTL Translator

# **Description**

The MC10H125 is a quad translator for interfacing data and control signals between the MECL section and saturated logic section of digital systems. The 10H part is a functional/pinout duplication of the standard MECL  $10K^{TM}$  family part, with 100% improvement in propagation delay, and no increase in power-supply current.

Outputs of unused translators will go to low state when their inputs are left open.

#### **Features**

- Propagation Delay, 2.5 ns Typical
- Voltage Compensated
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- MECL 10K Compatible
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant



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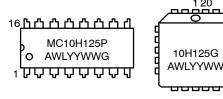
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PDIP-16 P SUFFIX CASE 648-08 PLLC-20 FN SUFFIX CASE 775-02

#### **MARKING DIAGRAMS\***



PDIP-16

PLLC-20

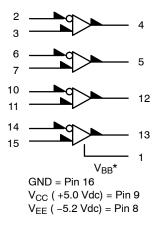
A = Assembly Location
 WL, L = Wafer Lot
 YY, Y = Year
 WW, W = Work Week
 G = Pb-Free Package

\*For additional marking information, refer to Application Note <u>AND8002/D</u>.

### ORDERING INFORMATION

| Device        | Package              | Shipping†       |
|---------------|----------------------|-----------------|
| MC10H125FNG   | PLLC-20<br>(Pb-Free) | 46 Units / Tube |
| MC10H125FNR2G | PLLC-20<br>(Pb-Free) | 500 Tape & Reel |
| MC10H125PG    | PDIP-16<br>(Pb-Free) | 25 Units / Tube |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



\*V<sub>BB</sub> to be used to supply bias to the MC10H125 only and bypassed (when used) with 0.01  $\mu$ F to 0.1  $\mu$ F capacitor to ground (0 V). V<sub>BB</sub> can source < 1.0 mA.

Figure 1. Logic Diagram

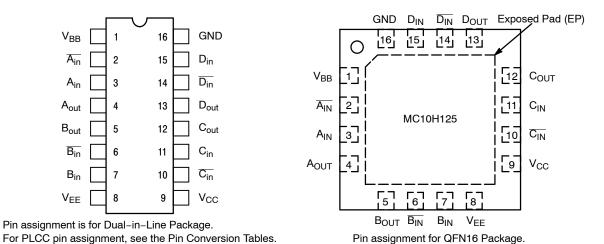


Figure 2. Pin Assignment

**Table 1. DIP CONVERSION TABLES** 

| 16-Pin DIL to 20-Pin      | PLCC |   |   |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |
|---------------------------|------|---|---|---|---|---|---|----|----|----|----|----|----|----|----|----|----|----|----|----|
| 16 PIN DIL                | 1    | 2 | 3 | 4 | 5 | 6 | 7 | 8  | 9  | 10 | 11 | 12 | 13 | 14 | 15 | 16 |    |    |    |    |
| 20 PIN PLCC               | 2    | 3 | 4 | 5 | 7 | 8 | 9 | 10 | 12 | 13 | 14 | 15 | 17 | 18 | 19 | 20 |    |    |    |    |
| 20-Pin DIL to 20-Pin PLCC |      |   |   |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |
| 20 PIN DIL                | 1    | 2 | 3 | 4 | 5 | 6 | 7 | 8  | 9  | 10 | 11 | 12 | 13 | 14 | 15 | 16 | 17 | 18 | 19 | 20 |
| 20 PIN PLCC               | 1    | 2 | 3 | 4 | 5 | 6 | 7 | 8  | 9  | 10 | 11 | 12 | 13 | 14 | 15 | 16 | 17 | 18 | 19 | 20 |

**Table 2. MAXIMUM RATINGS** 

| Symbol           | Characteristic                                | Rating                     | Unit |
|------------------|---|----------------------------|------|
| V <sub>EE</sub>  | Power Supply (V <sub>CC</sub> = 5.0 V)        | -8.0 to 0                  | Vdc  |
| V <sub>CC</sub>  | Power Supply (V <sub>EE</sub> = -5.2 V)       | 0 to +7.0                  | Vdc  |
| VI               | Input Voltage (V <sub>CC</sub> = 5.0 V)       | 0 to V <sub>EE</sub>       | Vdc  |
| T <sub>A</sub>   | Operating Temperature Range                   | 0 to +75                   | °C   |
| T <sub>stg</sub> | Storage Temperature Range - Plastic - Ceramic | -55 to +150<br>-55 to +165 | °C   |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Table 3. ELECTRICAL CHARACTERISTICS ( $V_{EE}$  = -5.2 V +5%;  $V_{CC}$  = 5.0 V + 5.0 %) (Note 2)

|                  |  | C     | )°      | 2     | <b>5</b> ° |       |        |      |
|------------------|--|-------|---------|-------|------------|-------|--------|------|
| Symbol           | Characteristic                                   | Min   | Max     | Min   | Max        | Min   | Max    | Unit |
| Ι <sub>Ε</sub>   | Negative Power<br>Supply Drain<br>Current        | -     | 44      | -     | 40         | _     | 44     | mA   |
| I <sub>CCH</sub> | Positive Power Supply                            | -     | 63      | -     | 63         | -     | 63     | mA   |
| I <sub>CCL</sub> | Drain Current                                    | -     | 40      | -     | 40         | -     | 40     | mA   |
| I <sub>inH</sub> | Input Current                                    | -     | 225     | -     | 145        | -     | 145    | μΑ   |
| I <sub>CBO</sub> | Input Leakage Current                            | -     | 1.5     | -     | 1.0        | -     | 1.0    | μΑ   |
| V <sub>OH</sub>  | High Output Voltage<br>I <sub>OH</sub> = −1.0 mA | 2.5   | -       | 2.5   | -          | 2.5   | -      | Vdc  |
| V <sub>OL</sub>  | Low Output Voltage<br>I <sub>OL</sub> = +20 mA   | -     | 0.5     | -     | 0.5        | -     | 0.5    | Vdc  |
| V <sub>IH</sub>  | High Input Voltage (Note 1)                      | -1.17 | -0.84   | -1.13 | -0.81      | -1.07 | -0.735 | Vdc  |
| $V_{IL}$         | Low Input Voltage (Note 1)                       | -1.95 | -1.48   | -1.95 | -1.48      | -1.95 | -1.45  | Vdc  |
| los              | Short Circuit Current                            | 60    | 150     | 60    | 150        | 50    | 150    | mA   |
| $V_{BB}$         | Reference Voltage                                | -1.38 | -1.27   | -1.35 | -1.25      | -1.31 | -1.19  | Vdc  |
| $V_{CMR}$        | Common Mode<br>Range (Note 3)                    | -     | -       | -2.85 | to +0.3    |       |        | V    |
|                  |  |       | Typical |       |            |       |        |      |
| $V_{PP}$         | Input Sensitivity (Note 4)                       |       |         | 1     | 150        |       |        | mV   |

When V<sub>BB</sub> is used as the reference voltage.
 Each MECL 10H™ series circuit has been designed to meet the specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained.

Differential input not to exceed 1.0 Vdc.
 150 mV<sub>p-p</sub> differential input required to obtain full logic swing on output.

**Table 4. AC CHARACTERISTICS** 

|                 |                    | <b>0</b> ° |     | 25   | <b>5</b> ° | 7   |     |      |
|-----------------|--------------------|------------|-----|------|------------|-----|-----|------|
| Symbol          | Characteristic     | Min        | Max | Min  | Max        | Min | Max | Unit |
| t <sub>pd</sub> | Propagation Delay  | 0.8        | 3.3 | 0.85 | 3.35       | 0.9 | 3.4 | ns   |
| t <sub>r</sub>  | Rise Time (Note 1) | 0.3        | 1.2 | 0.3  | 1.2        | 0.3 | 1.2 | ns   |
| t <sub>f</sub>  | Fall Time (Note 1) | 0.3        | 1.2 | 0.3  | 1.2        | 0.3 | 1.2 | ns   |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

1. Output Voltage = 1.0 V to 2.0 V.  $R_L$  = 500  $\Omega$  to GND and  $C_L$  = 25 pF to GND. Refer to Figure 1.

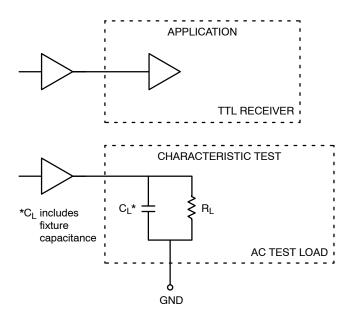


Figure 1. TTL Output Loading Used for Device Evaluation

### **APPLICATION INFORMATION**

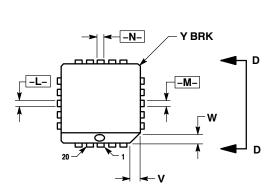
The MC10H125 incorporates differential inputs and Schottky TTL "totem pole" outputs. Differential inputs allow for use as an inverting/non-inverting translator or as a differential line receiver. The  $V_{BB}$  reference voltage is available on Pin 1 for use in single-ended input biasing. The outputs of the MC10H125 go to a low-logic level whenever the inputs are left floating, and a high-logic output level is achieved with a minimum input level of 150 m $V_{p-p}$ .

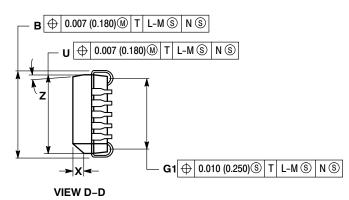
An advantage of this device is that MECL-level information can be received, via balanced twisted pair lines, in the TTL equipment. This isolates the MECL-logic from the noisy TTL environment. Power supply requirements are ground, +5.0 V and -5.2 V.

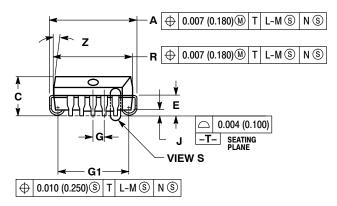
#### PACKAGE DIMENSIONS

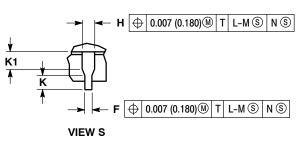
# **20 LEAD PLLC FN SUFFIX**

CASE 775-02 **ISSUE F** 









- 1. DIMENSIONS AND TOLERANCING PER ANSI Y14.5M,
- 2. DIMENSIONS IN INCHES.
  3. DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD

  OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.

- PARTING LINE.

  4. DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.

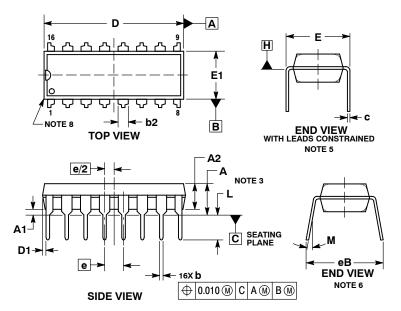
  5. DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.

  6. DIMENSIONS IN THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
  7. DIMENSION H DOES NOT INCLUDE DAMBAR
- DIMENSION OF INTRUSION. THE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

|     | INC   | HES   | MILLIMETERS |       |  |  |  |
|-----|-------|-------|-------------|-------|--|--|--|
| DIM | MIN   | MAX   | MIN         | MAX   |  |  |  |
| Α   | 0.385 | 0.395 | 9.78        | 10.03 |  |  |  |
| В   | 0.385 | 0.395 | 9.78        | 10.03 |  |  |  |
| С   | 0.165 | 0.180 | 4.20        | 4.57  |  |  |  |
| E   | 0.090 | 0.110 | 2.29        | 2.79  |  |  |  |
| F   | 0.013 | 0.021 | 0.33        | 0.53  |  |  |  |
| G   | 0.050 | BSC   | 1.27        | BSC   |  |  |  |
| н   | 0.026 | 0.032 | 0.66        | 0.81  |  |  |  |
| J   | 0.020 |       | 0.51        | -     |  |  |  |
| K   | 0.025 |       | 0.64        | -     |  |  |  |
| R   | 0.350 | 0.356 | 8.89        | 9.04  |  |  |  |
| Ω   | 0.350 | 0.356 | 8.89        | 9.04  |  |  |  |
| ٧   | 0.042 | 0.048 | 1.07        | 1.21  |  |  |  |
| W   | 0.042 | 0.048 | 1.07        | 1.21  |  |  |  |
| Х   | 0.042 | 0.056 | 1.07        | 1.42  |  |  |  |
| Υ   |       | 0.020 |             | 0.50  |  |  |  |
| Z   | 2 °   | 10 °  | 2 °         | 10 °  |  |  |  |
| G1  | 0.310 | 0.330 | 7.88        | 8.38  |  |  |  |
| K1  | 0.040 |       | 1.02        |       |  |  |  |

#### PACKAGE DIMENSIONS

## PDIP-16 P SUFFIX CASE 648-08 ISSUE V



#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M. 1994.
- 2. CONTROLLING DIMENSION: INCHES.
- DIMENSIONS A, A1 AND L ARE MEASURED WITH THE PACKAGE SEATED IN JEDEC SEATING PLANE GAUGE GS-3.
   DIMENSIONS D, D1 AND E1 DO NOT INCLUDE MOLD FLASH
- 4. DIMENSIONS D, DT AND ET DO NOT INCLUDE MOLD FLASH
  OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS ARE
  NOT TO EXCEED 0.10 INCH.

  5. DIMENSION E IS MEASURED AT A POINT 0.015 BELOW DATUM
- DIMENSION E IS MEASURED AT A POINT 0.015 BELOW DATUM PLANE H WITH THE LEADS CONSTRAINED PERPENDICULAR TO DATUM C.
- 6. DIMENSION 6B IS MEASURED AT THE LEAD TIPS WITH THE LEADS UNCONSTRAINED.
- DATUM PLANE H IS COINCIDENT WITH THE BOTTOM OF THE LEADS, WHERE THE LEADS EXIT THE BODY.
- 8. PACKAGE CONTOUR IS OPTIONAL (ROUNDED OR SQUARE CORNERS)

|     | INC   | HES   | MILLIMETERS |       |  |  |  |
|-----|-------|-------|-------------|-------|--|--|--|
| DIM | MIN   | MAX   | MIN         | MAX   |  |  |  |
| Α   |       | 0.210 |             | 5.33  |  |  |  |
| A1  | 0.015 |       | 0.38        |       |  |  |  |
| A2  | 0.115 | 0.195 | 2.92        | 4.95  |  |  |  |
| b   | 0.014 | 0.022 | 0.35        | 0.56  |  |  |  |
| b2  | 0.060 | TYP   | 1.52        | TYP   |  |  |  |
| С   | 0.008 | 0.014 | 0.20        | 0.36  |  |  |  |
| D   | 0.735 | 0.775 | 18.67       | 19.69 |  |  |  |
| D1  | 0.005 |       | 0.13        |       |  |  |  |
| E   | 0.300 | 0.325 | 7.62        | 8.26  |  |  |  |
| E1  | 0.240 | 0.280 | 6.10        | 7.11  |  |  |  |
| е   | 0.100 | BSC   | 2.54        | BSC   |  |  |  |
| eВ  |       | 0.430 |             | 10.92 |  |  |  |
| L   | 0.115 | 0.150 | 2.92        | 3.81  |  |  |  |
| M   |       | 10°   |             | 10°   |  |  |  |

| STYLE 1 | :       | STYLE 2 | :            |
|---------|---------|---------|--------------|
| PIN 1.  | CATHODE | PIN 1.  | COMMON DRAIN |
| 2.      | CATHODE | 2.      | COMMON DRAIN |
| 3.      | CATHODE | 3.      | COMMON DRAIN |
| 4.      | CATHODE | 4.      | COMMON DRAIN |
| 5.      | CATHODE | 5.      | COMMON DRAIN |
| 6.      | CATHODE | 6.      | COMMON DRAIN |
| 7.      | CATHODE | 7.      | COMMON DRAIN |
| 8.      | CATHODE | 8.      | COMMON DRAIN |
| 9.      | ANODE   | 9.      | GATE         |
| 10.     | ANODE   | 10.     | SOURCE       |
| 11.     | ANODE   | 11.     | GATE         |
| 12.     | ANODE   | 12.     | SOURCE       |
| 13.     | ANODE   | 13.     | GATE         |
| 14.     | ANODE   | 14.     | SOURCE       |
| 15.     | ANODE   | 15.     | GATE         |
| 16.     | ANODE   | 16.     | SOURCE       |

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